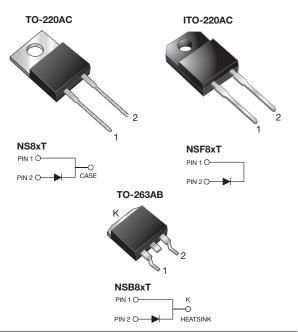


Vishay General Semiconductor

Glass Passivated General Purpose Plastic Rectifier



PRIMARY CHARACTERISTICS							
I _{F(AV)}	8.0 A						
V _{RRM}	50 V to 1000 V						
I _{FSM}	125 A						
V _F	1.1 V						
T _J max.	150 °C						
Package	TO-220AC, ITO-220AC, TO-263AB						
Diode variation	Single						

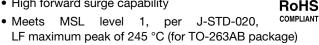
FEATURES

Power pack





· High forward surge capability



- Solder dip 275 °C max. 10 s, per JESD 22-B106 (for TO-220AC and ITO-220AC package)
- AEC-Q101 qualified
- · Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes application.

MECHANICAL DATA

Case: TO-220AC, ITO-220AC, TO-263AB

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commerical grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test. HE3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

Mounting Torque: 10 in-lbs maximum

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	NS8AT	NS8BT	NS8DT	NS8GT	NS8JT	NS8KT	NS8MT	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	٧
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _C = 100 °C	I _{F(AV)}	8.0					Α		
Peak forward surge current 8.3 ms single sine-wave superimposed on rated load	I _{FSM}	125					Α		
Operating junction and storage temperature range	T _J , T _{STG}	G - 55 to + 150						°C	
Isolation voltage (ITO-220AC only) from terminal to heatsink t = 1 min	V _{AC}	1500					V		

NS8xT, NSF8xT, NSB8xT

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)											
PARAMETER	TEST C	CONDITIONS	SYMBOL	NS8AT	NS8BT	NS8DT	NS8GT	NS8JT	NS8KT	NS8MT	UNIT
Maximum instantaneous forward voltage	8.0 A	T _J = 25 °C	V _F ⁽¹⁾				1.1				V
Maximum DC reverse current		T _J = 25 °C	1_				10				μA
at rated DC blocking voltage		T _J = 100 °C	I _R	100						μΑ	
Typical junction capacitance	4.0 V, 1	MHz	CJ	55				pF			

Note

 $^{^{(1)}}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	NSFXT	NSBXT	UNIT				
Typical thermal resistance from junction to case	$R_{\theta JC}$	3.0	5.0	3.0	°C/W		

ORDERING INFORMATION (Example)									
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
TO-220AC	NS8JT-E3/45	1.80	45	50/tube	Tube				
ITO-220AC	NSF8JT-E3/45	1.95	45	50/tube	Tube				
TO-263AB	NSB8JT-E3/45	1.77	45	50/tube	Tube				
TO-263AB	NSB8JT-E3/81	1.77	81	800/reel	Tape and reel				
TO-220AC	NS8JTHE3/45 ⁽¹⁾	1.80	45	50/tube	Tube				
ITO-220AC	NSF8JTHE3/45 (1)	1.95	45	50/tube	Tube				
TO-263AB	NSB8JTHE3/45 (1)	1.77	45	50/tube	Tube				
TO-263AB	NSB8JTHE3/81 (1)	1.77	81	800/reel	Tape and reel				

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

100

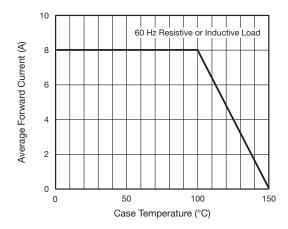
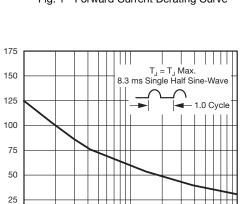


Fig. 1 - Forward Current Derating Curve



Peak Forward Surge Current (A)

0

Number of Cycles at 60 Hz

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

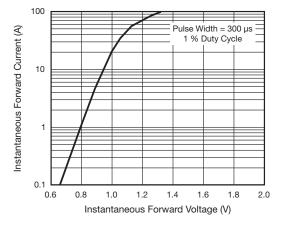


Fig. 3 - Typical Instantaneous Forward Characteristics

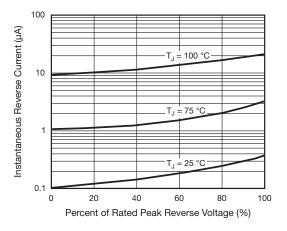


Fig. 4 - Typical Reverse Characteristics

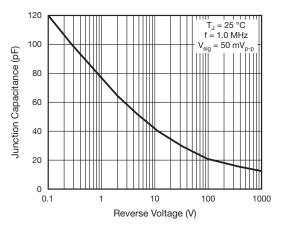
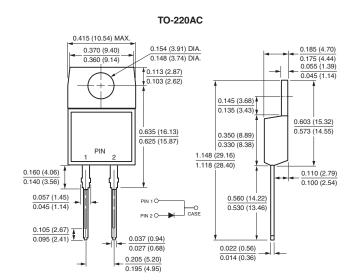


Fig. 5 - Typical Junction Capacitance Per Leg



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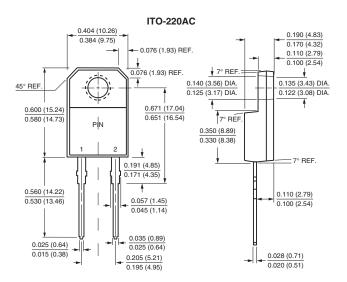
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



0.027 (0.686)

0.105 (2.67)

0.095 (2.41)



0.411 (10.45) 0.190 (4.83) 0.380 (9.65) 0.055 (1.40) 0.160 (4.06) 0.245 (6.22) 0.045 (1.14) MIN. 0.055 (1.40) 0.360 (9.14) 0.047 (1.19) 0.320 (8.13) 0.624 (15.85) Κ 2 0.591 (15.00) -0 to 0.01 (0 to 0.254) 0.110 (2.79) 0.090 (2.29) 0.037 (0.940) 0.021 (0.53)

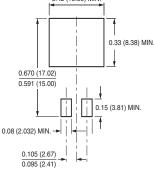
0.205 (5.20)

0.195 (4.95)

TO-263AB

0.42 (10.66) MIN.

Mounting Pad Layout



0.014 (0.36)

0.140 (3.56)

0.110 (2.79)



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